

04-11-2003



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DELPHI TECHNOLOGIES, INC.

Legal Staff

P.O. Box 5052

Mail Code: 480-410-202

Troy, Michigan 48007-5052

3/28/03

JC586 U.S. PTO
10/401850
03/28/03

Box Assignments
Assistant Commissioner for Patents
Washington, D.C. 20231

03/28/03

Enclosed for recording is Assignment documentation for the following patent application:

Attorney Docket No. : DP-307628

(1) Assignor/Inventors : SCOTT D. BRANDENBURG
THOMAS A. DEGENKOLB
BRUCE A. MYERS

(2) Assignee : DELPHI TECHNOLOGIES, INC.
Legal Staff - Mail Code : 480-410-202
P.O. Box 5052
TROY, MICHIGAN

(3) Assignment of patent application

(4) Application number:

If blank, this documentation is filed together with the patent application.

(5) Address correspondence to : JIMMY L. FUNKE
DELPHI TECHNOLOGIES, INC.
Legal Staff
P.O. Box 5052
Mail Code: 480-410-202
Troy, Michigan 48007-5052

(6) Number of applications : 1
Total Fee : 40.00

(7) Date documentation executed: 1/2/03 + 1/6/03

(8) Not applicable

(9) To the best of my knowledge and belief, the information contained on this cover sheet is true and correct and any copy submitted is a true copy of the original document.

Title : OVERMOLDED ELECTRONIC PACKAGE INCLUDING CIRCUIT-CARRYING
SUBSTRATE

Please charge the \$ 40.00 assignment recording fee to DELPHI TECHNOLOGIES INC., Deposit Account
No. 50-0831.

04/10/2003 TDIAZ1 00000066 500831 10401850
FC:8421 40.00 CH

Jimmy L. Funke
JIMMY L. FUNKE
(248) 813-1214

Total number of pages including cover sheet, attachments and document: 2

Enclosures

PATENT
REEL: 013931 FRAME: 0828

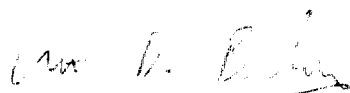
ASSIGNMENT

Pursuant to an agreement with my employer, I formally assign to DELPHI TECHNOLOGIES INC., the entire right, title and interest, in all countries, in the improvements set forth in the United States patent application DP-307628 entitled

**OVERMOLDED ELECTRONIC PACKAGE INCLUDING CIRCUIT-CARRYING
SUBSTRATE**

for which I executed a declaration dated as indicated below. If the patent application has been filed, I authorize attorney JIMMY L. FUNKE to insert the application number and filing date of said application here in parentheses (_____ filed _____) when known.

Inventor's signature



Date

1/2/03

Full name :

SCOTT D. BRANDENBURG

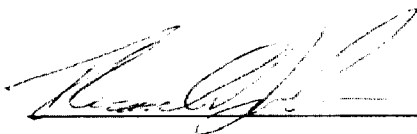
Declaration dated :

Residence :

KOKOMO, INDIANA

1/2/03

Inventor's signature



Date

1/6/03

Full name :

THOMAS A. DEGENKOLB

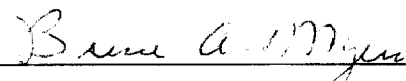
Declaration dated :

Residence :

NOBLESVILLE, IN

1/6/03

Inventor's signature



Date

2 Jan 2003

Full name :

BRUCE A. MYERS

Declaration dated :

Residence :

KOKOMO, INDIANA

2 Jan 2003